

Low Profile Miniature SMD AT Crystal

800kHz to 1.35MHz

FEATURES

- Extensional mode resonator, 760kHz to 1.35MHz
- **Designed for low power applications**
- Ideal microprocessor clock crystal
- Low ageing
- Full military testing available

DESCRIPTION

CX3SM crystals consist of a high quality extensional mode resonator in a rugged, hermetically sealed ceramic package.

SPECIFICATION

Specifications stated are typical at 25°C unless otherwise indicated.

Specifications may change without notice.		
Frequency Range:	800kHz to 1.35MHz	
Standard Calibration Tolerance*:	±500ppm (0.05%)	
	±1000ppm (0.1%)	
	±10000ppm (1.0%)	
Load Capacitance:	7pF	
Motional Resistance (R1):	5kΩ maximum	
Motional Capacitance (C1):	1.2fF	
Quality Factor (Q):	150k	
Shunt Capacitance (C0):	1.0pF	
Drive Level:	3μW maximum	
Turning Point (T0**):	35°C	
Temperature Coefficient (k):	-0.035ppm/°C2	
Ageing First Year:	±5ppm maximum	
Shock, Survival:	1000g, 0.3ms, ½ sine	
Vibration, Survival:	10g rms, 20~1000Hz random	
Operating Temperature Range:	-10°C to +70°C (Commercial)	
	-40°C to +85°C (Industrial)	
	-55°C to +125°C (Military)	
Storage Temperature Range:	-55° to +125°C	

- Tighter frequency calibration is available.
- Other turning point is available.

Maximum Process Temperature:

Turning Point Temperature

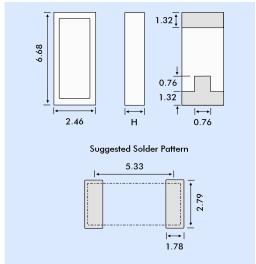
Note: Frequency f at temperature T is related to frequency Fo at turning point temperature To by:

$$\frac{\text{f-fo}}{\text{fo}} = k(\text{T-To})^2$$

+260°C for 20 seconds

OUTLINE & DIMENSIONS





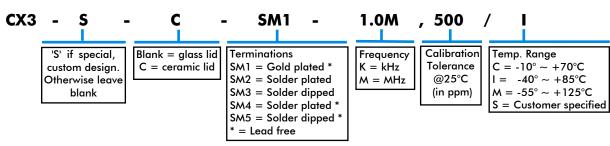
Dim. H	Glass Lid	Ceramic Lid
SM1	1.35	1.70
SM2	1.40	1.75
SM3	1.47	1.83
SM4	1.40	1.75
SM5	1.47	1.83

PACKAGING OPTIONS

CX3SM crystals are available either tray packed (<250pcs) or tape and reel (>250 pieces).

16mm tape, 178mm or 330mm reels (EIA 418).

HOW TO ORDER CX3SM CRYSTALS

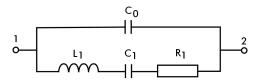




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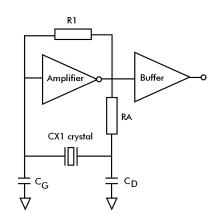
800kHz to 1.35MHz

CRYSTAL EQUIVALENT CIRCUIT



- **R1 Motional Resistance** C1 Motional Capacitance
- L1 Motional Inductance C0 Shunt Capacitance

CONVENTIONAL CMOS PIERCE OSCILLATOR CIRCUIT



TERMINATIONS - PLATING

Designation	Termination
SM1	Gold Plated (Lead Free)
SM2	Solder Plated
SM3	Solder Dipped
SM4	Solder Plated (Lead Free)
SM5	Solder Dipped (Lead Free)

TYPICAL APPLICATION FOR A **PIERCE OSCILLATOR**

The low profile CX miniature crystal is ideal for use in small, high density, battery operated portable products. The CX crystal designed in a Pierce oscillator (single inverter) circuit provides very low current consumption and high stability. A conventional Pierce oscillator is shown above. The crystal is effectively inductive and in a Pi network circuit with CD and CG provides the additional phase shift to sustain oscillation. The oscillation frequency (fo) is 15 to 250ppm above the crystal's resonant frequency (fs).

RA is used to limit the crystal's drive level by forming a voltage divider between RA and CD. RA also stabilizes the oscillator against changes in the amplifier's output resistance (Ro). RA should be increased for higher voltage operation.

Load Capacitance

The CX crystal calibration tolerance is influenced by the effective circuit capacitances, specified as the load capacitance (CL). CL is approximately equal to:

$$C_L = \frac{C_D \times C_G}{C_D + C_G} + C_S$$

Note: C^D and C^G include stray layout-induced capacitance to ground and Cs is the stray shunt capacitance between the crystal terminal. In practice, the effective value of C^L will be less than that calculated from CD, CG and CS values because of the effect of the amplifier output resistance. Cs should be minimized.

The oscillation frequency (fo) is approximately equal to:

$$f_O = f_S \left[1 + \frac{C_1}{2(C_O + C_L)} \right]$$

Where

Fs = Series resonant frequency of the crystal

C1 = Motional Capacitance Co = Shunt Capacitance